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Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are Embedded - System On Chip (SoC)?

System On Chip (SoC) integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions. SoCs combine a central

Details

Product Status	Active
Architecture	MCU, FPGA
Core Processor	ARM® Cortex®-M3
Flash Size	256KB
RAM Size	64KB
Peripherals	DDR, PCIe, SERDES
Connectivity	CANbus, Ethernet, I ² C, SPI, UART/USART, USB
Speed	166MHz
Primary Attributes	FPGA - 50K Logic Modules
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	400-LFBGA
Supplier Device Package	400-VFBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/m2s050-1vf400

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

2.3.11 Global Resource Characteristics

The IGLOO2 and SmartFusion2 SoC FPGA devices offer a powerful, low skew global routing network which provides an effective clock distribution throughout the FPGA fabric. See *UG0445: IGLOO2 FPGA* and SmartFusion2 SoC FPGA Fabric User Guide for the positions of various global routing resources.

The following table lists the 150 device global resources in worst commercial-case conditions when T_J = 85 °C, V_{DD} = 1.14 V.

			-1	–Std		
Parameter	Symbol	Min	Max	Min	Max	Unit
Input low delay for global clock	T _{RCKL}	0.83	0.911	0.831	0.913	ns
Input high delay for global clock	Т _{RCKH}	1.457	1.588	1.715	1.869	ns
Maximum skew for global clock	T _{RCKSW}		0.131		0.154	ns

Table 225 • 150 Device Global Resource

The following table lists the 090 device global resources in worst commercial-case conditions when T_J = 85 °C, V_{DD} = 1.14 V.

Table 226 • 090 Device Global Resource

		–1		-Std		
Parameter	Symbol	Min	Max	Min	Max	Unit
Input low delay for global clock	T _{RCKL}	0.835	0.888	0.833	0.886	ns
Input high delay for global clock	Т _{RCKH}	1.405	1.489	1.654	1.752	ns
Maximum skew for global clock	T _{RCKSW}		0.084		0.098	ns

The following table lists the 050 device global resources in worst commercial-case conditions when T_J = 85 °C, V_{DD} = 1.14 V.

Table 227 • 050 Device Global Resource

		–1		-Std		
Parameter	Symbol	Min	Max	Min	Max	Unit
Input low delay for global clock	T _{RCKL}	0.827	0.897	0.826	0.896	ns
Input high delay for global clock	Т _{RCKH}	1.419	1.53	1.671	1.8	ns
Maximum skew for global clock	T _{RCKSW}		0.111		0.129	ns

The following table lists the 025 device global resources in worst commercial-case conditions when T_J = 85 °C, V_{DD} = 1.14 V.

Table 228 • 025 Device Global Resource

		–1		-Std		
Parameter	Symbol	Min	Max	Min	Max	Unit
Input low delay for global clock	T _{RCKL}	0.747	0.799	0.745	0.797	ns
Input high delay for global clock	Т _{RCKH}	1.294	1.378	1.522	1.621	ns
Maximum skew for global clock	T _{RCKSW}		0.084		0.099	ns